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FAIRCHILD SEMICONDUCTOR®

Dual P-Channel 1.8 V Specified PowerTrench[®] MOSFET

General Description

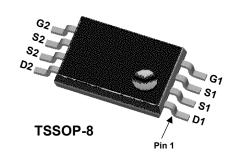
This P-Channel –1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

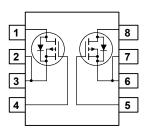
Applications

- Power management
- Load switch
- Battery protection

Features

- Low gate charge(26nC typical)
- High performance trench technology for extremely
 low R_{DS(ON)}
- Low profile TSSOP-8 package



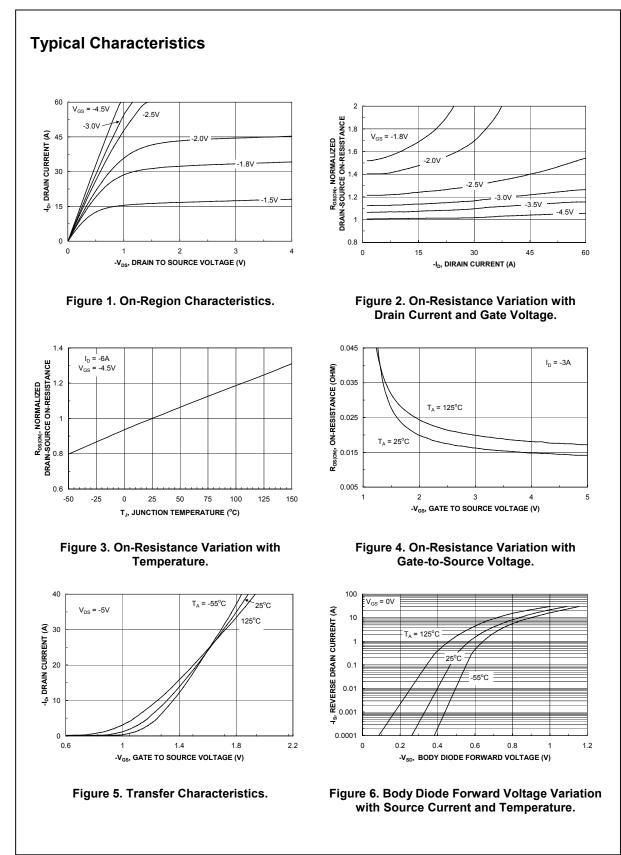


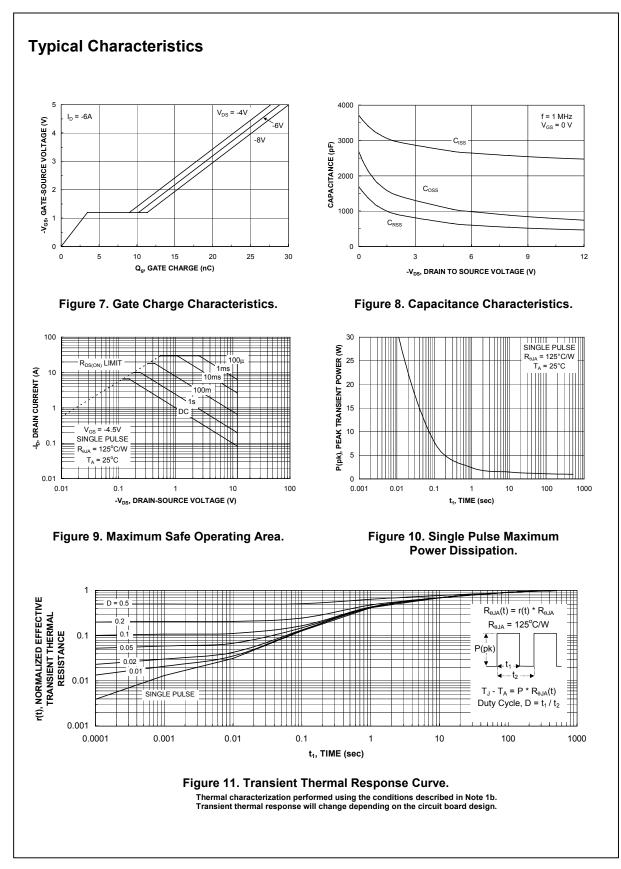
Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings		
V _{DSS}	Drain-Source Voltage		-12		
V _{GSS}	Gate-Source Voltage		±8		
I _D	Drain Current – Continuous (Note 1)		-6		
	– Pulsed		-30		
PD	Power Dissipation for Single Operation	I (Note 1a)	1.3	W	
			1		
		(Note 1b)	I		
T _J , T _{STG}	Operating and Storage Junction Tempe	· · · ·	–55 to +150	0°	
Therma	Operating and Storage Junction Tempe I Characteristics Thermal Resistance, Junction-to-Ambie	erature Range		°C °C/W	
	I Characteristics	erature Range	-55 to +150		
Therma R _{θJA}	I Characteristics Thermal Resistance, Junction-to-Ambie e Marking and Ordering Ir	erature Range ent (Note 1a) (Note 1b)	-55 to +150 100		

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0// 01	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Char	racteristics	L				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-12			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-2		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -10 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -8 V, \qquad V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-0.5	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		2.7		mV/°(
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{c} V_{GS} = -4.5 \ V, I_D = -6 \ A \\ V_{GS} = -2.5 \ V, I_D = -5 \ A \\ V_{GS} = -1.8 \ V, I_D = -4 \ A \\ V_{GS} = -4.5 \ V, I_D = -6A, \ T_J = 125^{\circ}C \end{array} $		14 17 22 18	18 22 30 25	mΩ
I _{D(on)}	On–State Drain Current	$ \begin{array}{c} V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -6\text{A}, \text{ T}_{J} = 125^{\circ}\text{C} \\ V_{GS} = -4.5 \text{ V}, \text{ V}_{DS} = -5 \text{ V} \end{array} $	-30			A
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -6 A$		32		S
Dvnamio	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -6 V$, $V_{GS} = 0 V$,		2644		pF
Coss	Output Capacitance	f = 1.0 MHz		987		pF
C _{rss}	Reverse Transfer Capacitance			602		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -6 V$, $I_D = -1 A$,		14	25	ns
t _r	Turn–On Rise Time	$V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$		9.1	18	ns
t _{d(off)}	Turn–Off Delay Time	-	-	122	195	ns
t _f	Turn–Off Fall Time	-		89	142	ns
Q _g	Total Gate Charge	$V_{DS} = -6 V$, $I_D = -6 A$,		26	36	nC
	Gate–Source Charge	$V_{GS} = -4.5 V$		4		nC
	Gate–Drain Charge	-	-	7		nC
Q _{gs}						
Q _{gs} Q _{gd}	ource Diode Characteristics	and Maximum Ratings				
Q _{gs} Q _{gd}	ource Diode Characteristics				-1.1	A





FDW2508P Rev. E (W)

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